# 74F652 Transceivers/Registers

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SEMICONDUCTOR

#### 74F652 Transceivers/Registers

#### **General Description**

These devices consist of bus transceiver circuits with D-type flip-flops, and control circuitry arranged for multiplexed transmission of data directly from the input bus or from internal registers. Data on the A or B bus will be clocked into the registers as the appropriate clock pin goes to HIGH logic level. Output Enable pins (OEAB, OEBA) are provided to control the transceiver function.

#### Features

- Independent registers for A and B buses
- Multiplexed real-time and stored data
- 74F652 non-inverting data path

#### **Ordering Code:**

M24B	24-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide
N24C	24-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide
le	N24C









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## 74F652

#### Unit Loading/Fan Out

Pin Names	Description	U.L.	Input I <sub>IH</sub> /I <sub>IL</sub>		
Pin Names	Description	HIGH/LOW	Output I <sub>OH</sub> /I <sub>OL</sub>		
A <sub>0</sub> -A <sub>7</sub> , B <sub>0</sub> -B <sub>7</sub>	A and B Inputs/	1.0/1.0	20 μA/–0.6 mA		
	3-STATE Outputs	600/106.6 (80)	-12 mA/64 mA (48 mA)		
CPAB, CPBA	Clock Inputs	1.0/1.0	20 µA/–0.6 mA		
SAB, SBA	Select Inputs	1.0/1.0	20 µA/–0.6 mA		
OEAB, OEBA	Output Enable Inputs	1.0/1.0	20 µA/–0.6 mA		

#### **Function Table**

		Input	S			Inputs/Outp	uts (Note 2)	Operating Made		
OEAB	OEBA	СРАВ	СРВА	SAB	SBA	A <sub>0</sub> thru A <sub>7</sub>	B <sub>0</sub> thru B <sub>7</sub>	Operating Mode		
L	Н	H or L	H or L	Х	Х	Input Input		Isolation		
L	Н	~	\	Х	Х			Store A and B Data		
Х	Н	~	H or L	Х	Х	Input Not Specified		Store A, Hold B		
Н	Н	~	\	Х	Х	Input	Output	Store A in Both Registers		
L	Х	H or L	\	Х	Х	Not Specified	Input	Hold A, Store B		
L	L	~	Υ	Х	Х	Output	Input	Store B in Both Registers		
L	L	Х	Х	Х	L	Output	Input	Real-Time B Data to A Bus		
L	L	Х	H or L	Х	Н			Store B Data to A Bus		
Н	Н	Х	Х	L	Х	Input	Output	Real-Time A Data to B Bus		
Н	Н	H or L	Х	Н	Х			Stored A Data to B Bus		
Н	L	H or L	H or L	Н	Н	Output	Output	Stored A Data to B Bus and		
								Stored B Data to A Bus		

H = HIGH Voltage Level X = Immaterial L = LOW Voltage Level ~ = LOW-to-HIGH Clock Transition

Note 2: The data output functions may be enabled or disabled by various signals at OEAB or OEBA inputs. Data input functions are always enabled, i.e., data at the bus pins will be stored on every LOW-to-HIGH transition on the clock inputs.

#### **Functional Description**

In the transceiver mode, data present at the HIGH impedance port may be stored in either the A or B register or both.

The select (SAB, SBA) controls can multiplex stored and real-time.

The examples in Figure 1 demonstrate the four fundamental bus-management functions that can be performed with the Octal bus transceivers and receivers. Data on the A or B data bus, or both can be stored in the internal D flip-flop by LOW-to-HIGH transitions at the appropriate Clock Inputs (CPAB, CPBA) regardless of the Select or Output Enable Inputs. When SAB and SBA are in the real time transfer mode, it is also possible to store data without using the internal D flip-flops by simultaneously enabling OEAB and OEBA. In this configuration each Output reinforces its Input. Thus when all other data sources to the two sets of bus lines are in a HIGH impedance state, each set of bus lines will remain at its last state.



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#### Absolute Maximum Ratings(Note 3)

Storage Temperature	$-65^{\circ}C$ to $+150^{\circ}C$
Ambient Temperature under Bias	$-55^{\circ}C$ to $+125^{\circ}C$
Junction Temperature under Bias	-55°C to +150°C
V <sub>CC</sub> Pin Potential to Ground Pin	-0.5V to +7.0V
Input Voltage (Note 4)	-0.5V to +7.0V
Input Current (Note 4)	-30 mA to +5.0 mA
Voltage Applied to Output	
in HIGH State (with $V_{CC} = 0V$ )	
Standard Output	–0.5V to V <sub>CC</sub>
3-STATE Output	-0.5V to +5.5V
Current Applied to Output	
in LOW State (Max)	twice the rated I <sub>OL</sub> (mA)
ESD Last Passing Voltage (Min)	4000V

### Recommended Operating Conditions

Free Air Ambient Temperature Supply Voltage 74F652

0°C to +70°C +4.5V to +5.5V

Note 3: Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

Note 4: Either voltage limit or current limit is sufficient to protect inputs.

#### **DC Electrical Characteristics**

Symbol	Parameter		Min	Тур	Max	Units	V <sub>CC</sub>	Conditions
VIH	Input HIGH Voltage		2.0			V		Recognized as a HIGH Signal
VIL	Input LOW Voltage				0.8	V		Recognized as a LOW Signal
V <sub>CD</sub>	Input Clamp Diode Voltage				-1.2	V	Min	I <sub>IN</sub> = -18 mA (Non I/O Pins)
V <sub>OH</sub>	Output HIGH Voltage	10% V <sub>CC</sub>	2.0			V	Min	$I_{OH} = -15 \text{ mA} (A_n, B_n)$
V <sub>OL</sub>	Output LOW Voltage	10% V <sub>CC</sub>			0.55	V	Min	$I_{OL} = 64 \text{ mA} (A_n, B_n)$
I <sub>IH</sub>	Input HIGH				5.0	μA	Max	V <sub>IN</sub> = 2.7V
	Current				5.0	μΑ	wax	(Non I/O Pins)
I <sub>BVI</sub>	Input HIGH Current				7.0	μA	Max	V <sub>IN</sub> = 7.0V
	Breakdown Test				7.0	μΑ	IVIAX	$v_{\rm IN} = 7.0v$
I <sub>BVIT</sub>	Input HIGH Current				0.5	mA	Max	$V_{IN} = 5.5V$
	Breakdown (I/O)				0.5	mA	IVIAX	(A <sub>n</sub> , B <sub>n</sub> )
ICEX	Output HIGH				50	μA	Max	$V_{OUT} = V_{CC}$
	Leakage Current				50	μΑ	IVIAX	V <sub>OUT</sub> = V <sub>CC</sub>
V <sub>ID</sub>	Input Leakage		4.75			V	0.0	I <sub>ID</sub> = 1.9 μA
	Test		4.75			v	0.0	All Other Pins Grounded
I <sub>OD</sub>	Output Leakage				3.75	۸	0.0	VI <sub>IOD</sub> = 150 mV
	Circuit Current				3.75	μA	0.0	All Other Pins Grounded
IIL	Input LOW Current				-0.6	mA	Max	V <sub>IN</sub> = 0.5V (Non I/O Pins)
I <sub>IH</sub> + I <sub>OZH</sub>	Output Leakage Current				70	μΑ	Max	$V_{OUT} = 2.7V (A_n, B_n)$
I <sub>IL</sub> + I <sub>OZL</sub>	Output Leakage Current				-650	μΑ	Max	$V_{OUT} = 0.5V (A_n, B_n)$
los	Output Short-Circuit Current		-100		-225	mA	Max	$V_{OUT} = 0V$
I <sub>ZZ</sub>	Bus Drainage Test				500	μΑ	0.0V	V <sub>OUT</sub> = 5.25V
ICCH	Power Supply Current			105	135	mA	Max	V <sub>O</sub> = HIGH
I <sub>CCL</sub>	Power Supply Current			118	150	mA	Max	$V_0 = LOW$
I <sub>CCZ</sub>	Power Supply Current			115	150	mA	Max	V <sub>O</sub> = HIGH Z

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t<sub>PHL</sub>

t<sub>PLH</sub>

t<sub>PHL</sub>

#### **AC Electrical Characteristics**

Symbol	Parameter	V <sub>CC</sub> =	+25°C ₌ +5.0V 50 pF	$T_{A} = -55^{\circ}C \text{ to } +125^{\circ}C$ $V_{CC} = +5.0V$ $C_{L} = 50 \text{ pF}$		
		Min	Мах	Min	Max	
f <sub>MAX</sub>	Max. Clock Frequency	90		75		
t <sub>PLH</sub>	Propagation Delay	2.0	7.0	2.0	8.5	
t <sub>PHL</sub>	Clock to Bus	2.0	8.0	2.0	9.5	
t <sub>PLH</sub>	Propagation Delay	1.0	7.0	1.0	8.0	

1.0

2.0

2.0

#### **AC Operating Requirements**

Bus to Bus

Propagation Delay

SBA or SAB to A or B

		$T_{A} = +25^{\circ}C$ $V_{CC} = +5.0V$		$T_A = -55^{\circ}C$	C to +125°C	$T_A = 0^{\circ}C$			
Symbol	Parameter			$V_{CC} = +5.0V$		$V_{CC} = +5.0V$		Units	
		Min	Max	Min	Max	Min	Max		
t <sub>PZH</sub>	Enable Time	2.0	9.5	2.0	10.0	2.0	10.0		
t <sub>PZL</sub>	*OEBA to A	2.0	12.0	2.0	10.0	2.0	12.5		
t <sub>PHZ</sub>	Disable Time	1.0	7.5	1.0	9.0	1.0	8.0		
t <sub>PLZ</sub>	*OEBA to A	2.0	8.5	1.0	9.0	2.0	9.0	ns	
t <sub>PZH</sub>	Enable Time	2.0	9.5	2.0	10.0	2.0	10.0		
t <sub>PZL</sub>	OEAB to B	3.0	13.0	2.0	12.0	3.0	14.0		
t <sub>PHZ</sub>	Disable Time	2.0	9.0	1.0	9.0	2.0	10.0	ns	
t <sub>PLZ</sub>	OEAB to B	2.0	10.5	1.0	12.0	2.0	11.0	115	
t <sub>S</sub> (H)	Setup Time, HIGH or	5.0		5.0		5.0		ns	
t <sub>S</sub> (L)	LOW, Bus to Clock	5.0		5.0		5.0		115	
t <sub>H</sub> (H)	Hold Time, HIGH or	2.0		2.5		2.0		ns	
t <sub>H</sub> (L)	LOW, Bus to Clock	2.0		2.5		2.0		115	
t <sub>W</sub> (H)	Clock Pulse Width	5.0		5.0		5.0		ns	
t <sub>W</sub> (L)	HIGH or LOW	5.0		5.0		5.0		115	

6.5

8.5

8.0

1.0

2.0

2.0

8.0

11.0

10.0

 $T_A = 0^{\circ}C \text{ to } +70^{\circ}C$  $V_{CC} = +5.0V$ 

 $C_L = 50 \text{ pF}$ 

Max

8.0

9.0

7.5

7.0

9.5

9.0

Min

90 2.0

2.0

1.0

1.0

2.0

2.0

Units

MHz

ns

ns

ns





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